

Product Summary

Device	V(BR)DSS	Rds(on)	I _D T _A = 25°C
Q1	00) (0.45Ω @ V _{GS} = 4.5V	1066mA
Q2	20V	0.75Ω @ V _{GS} =- 4.5V	-845mA

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Power Supply Converter Circuits

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected Up to 2.5kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

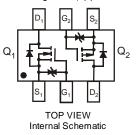
Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 1
- Ordering Information: See Page 1
- Weight: 0.006 grams (approximate)





TOP VIEW



Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
DMG1016UDW-7	Commercial	SOT-363	3000/Tape & Reel
DMG1016UDWQ-7	Automotive	SOT-363	3000/Tape & Reel

Notes: 1.1

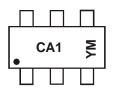
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



CA1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009) M = Month (ex: 9 = September)



Thermal Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	PD	330	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	379	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Maximum Ratings N-CHANNEL – Q1 @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V _{DSS}	20	V	
Gate-Source Voltage	V _{GSS}	±6	V		
Continuous Drain Current (Note 5)	Steady State	T _A = 25°C T _A = 85°C	ID	1066 690	mA

Maximum Ratings P-CHANNEL - Q2 @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V _{DSS}	-20	V	
Gate-Source Voltage	V _{GSS}	±6	V		
Continuous Drain Current (Note 5)	Steady State	T _A = 25°C T _A = 85°C	ID	-845 -548	mA

Notes: 5. Device mounted on FR-4 PCB with minimum recommended pad layout.

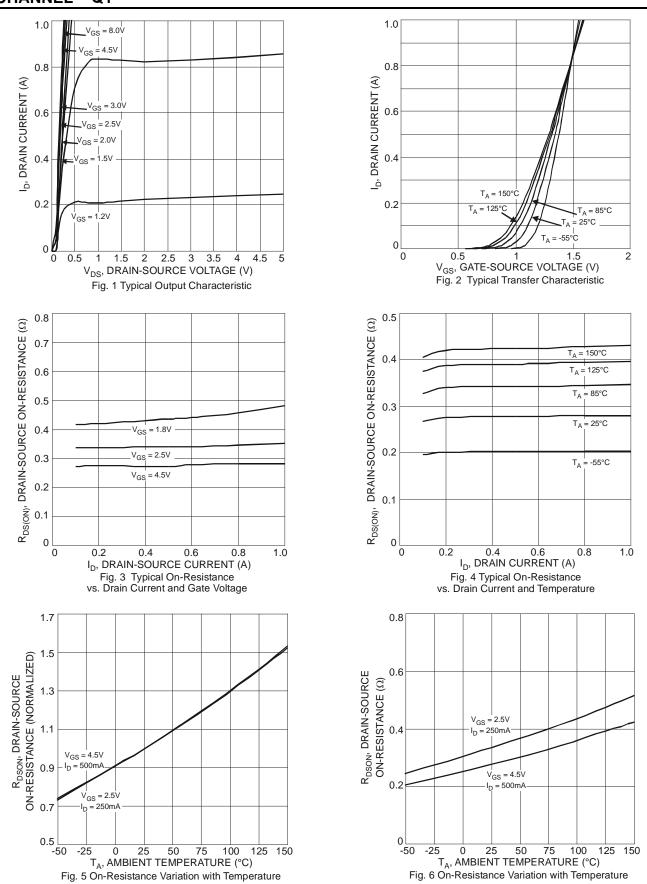
Electrical Characteristics N-CHANNEL – Q1 @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage		BV _{DSS}	20	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	$@T_{c} = 25^{\circ}C$	I _{DSS}	-	-	100	nA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage		I _{GSS}	-	-	±1.0	μA	$V_{GS} = \pm 4.5 V$, $V_{DS} = 0 V$
ON CHARACTERISTICS (Note 6)				•			
Gate Threshold Voltage		V _{GS(th)}	0.5	-	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		R _{DS (ON)}		0.3	0.45		$V_{GS} = 4.5V, I_D = 600mA$
Static Drain-Source On-Resistance			-	0.4	0.6	Ω	$V_{GS} = 2.5V, I_D = 500mA$
			× /	0.5	0.75		$V_{GS} = 1.8V, I_D = 350mA$
Forward Transfer Admittance		Y _{fs}	-	1.4	-	S	$V_{DS} = 10V, I_D = 400mA$
Diode Forward Voltage (Note 6)		V _{SD}	-	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 150 \text{mA}$
DYNAMIC CHARACTERISTICS (Note 7)							·
Input Capacitance		Ciss	-	60.67	-	pF	
Output Capacitance		Coss	-	9.68	-	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance		Crss	-	5.37	-	pF	
Total Gate Charge (4.5V)		Qg	-	736.6	-	nC	
Gate-Source Charge		Q _{gs}	-	93.6	-	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250mA$
Gate-Drain Charge		Q _{gd}	-	116.6	-	nC	$-1_D = 23011A$
Turn-On Delay Time		t _{D(on)}	-	5.1	-	ns	
Turn-On Rise Time		tr	-	7.4	-	ns	V _{DD} = 10V, V _{GS} = 4.5V,
Turn-Off Delay Time		t _{D(off)}	-	26.7	-	ns	$R_L = 47^{\bullet}$, $R_G = 10^{\bullet}$,
Turn-Off Fall Time		t _f	-	12.3	-	ns	1

Notes: 6. Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to production testing.



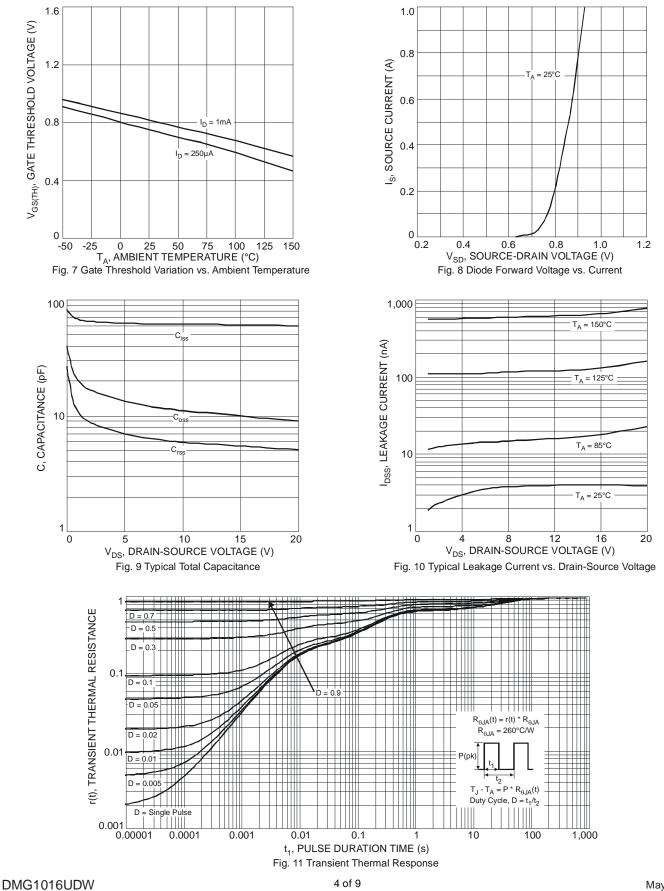
N-CHANNEL - Q1



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N-CHANNEL – Q1 (continued)



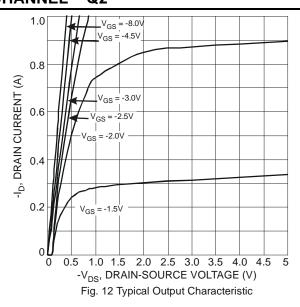


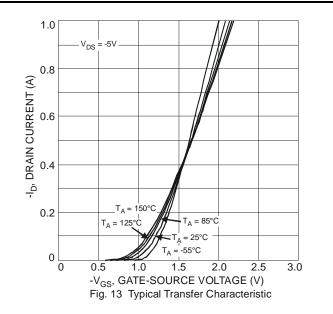
Electrical Characteristics P-CHANNEL – Q2@T_A = 25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)		-						
Drain-Source Breakdown Voltage		BV _{DSS}	-20	-	-	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current	@T _c = 25°C	I _{DSS}	-	-	-100	nA	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage		IGSS	-	-	±2.0	μA	$V_{GS} = \pm 4.5 V$, $V_{DS} = 0 V$	
ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage		V _{GS(th)}	-0.5	-	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
				0.5	0.75		$V_{GS} = -4.5V, I_D = -430mA$	
Static Drain-Source On-Resistance		R _{DS (ON)}	-	0.7	1.05	Ω	$V_{GS} = -2.5V, I_D = -300mA$	
				1.0	1.5		$V_{GS} = -1.8V, I_D = -150mA$	
Forward Transfer Admittance		Y _{fs}	-	0.9	-	S	$V_{DS} = -10V, I_D = -250mA$	
Diode Forward Voltage (Note 6)		V _{SD}	-	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -150mA$	
DYNAMIC CHARACTERISTICS (Note 7)							<u>.</u>	
Input Capacitance		Ciss	-	59.76	-	pF	V _{DS} = -16V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance		Coss	-	12.07	-	pF		
Reverse Transfer Capacitance		C _{rss}	-	6.36	-	pF	-1 = 1.0MHZ	
Total Gate Charge (4.5V)		Qg	-	622.4	-	рС		
Gate-Source Charge		Q _{gs}	-	100.3	-	pC	$V_{GS} = -4.5V, V_{DS} = -10V,$	
Gate-Drain Charge		Q _{gd}	-	132.2	-	рС	$I_{\rm D} = -250 {\rm mA}$	
Turn-On Delay Time		t _{D(on)}	-	5.1	-	ns		
Turn-On Rise Time		tr	-	8.1	-	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$	
Turn-Off Delay Time		t _{D(off)}	-	28.4	-	ns	$R_G = 10^{\bullet}$, $R_L = 47^{\bullet}$	
Turn-Off Fall Time		t _f	-	20.72	-	ns		

Notes: 6. Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to production testing

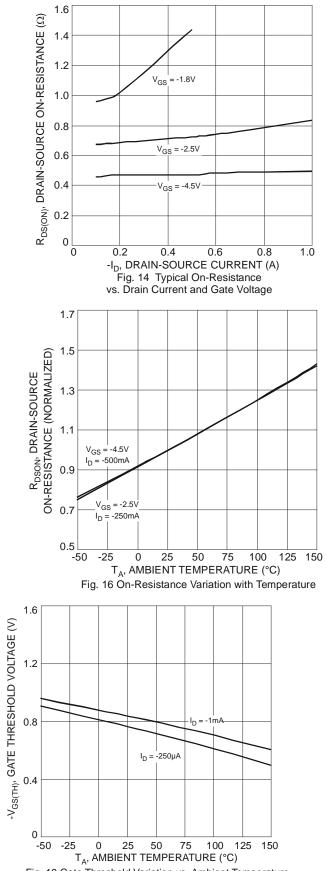
P-CHANNEL – Q2

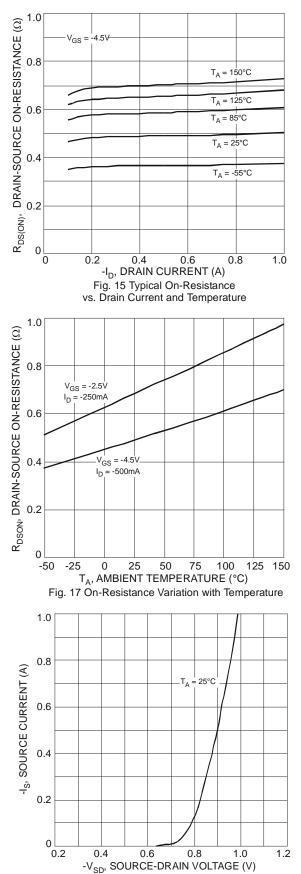




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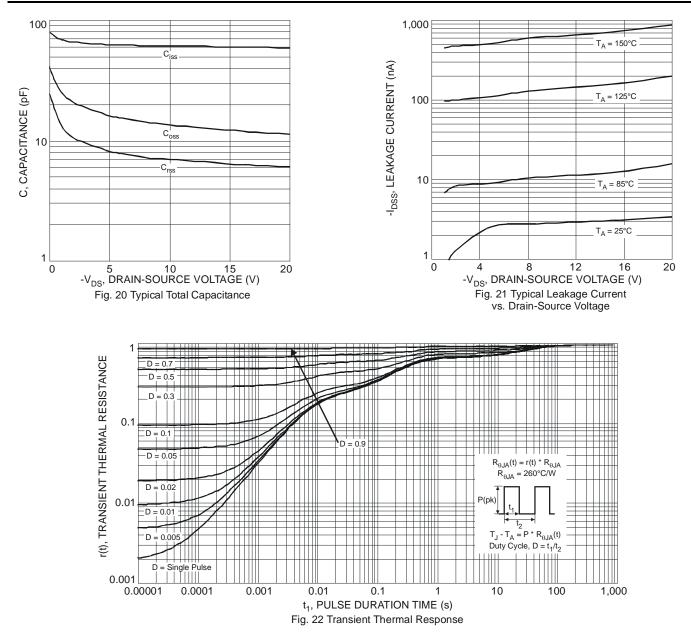






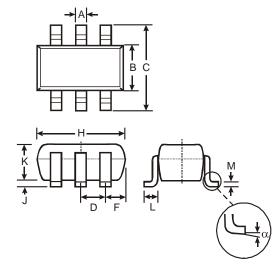


P-CHANNEL – Q2 (continued)



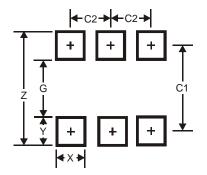


Package Outline Dimensions



	SOT-363					
Dim	Min	Max				
Α	0.10	0.30				
В	1.15	1.35				
С	2.00	2.20				
D	0.65	Тур				
F	0.40	0.45				
Н	1.80	2.20				
J	0 0.10					
κ	0.90 1.00					
L	0.25 0.40					
М	0.10	0.22				
α	0°	8°				
All Di	All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.5
G	1.3
X	0.42
Y	0.6
C1	1.9
C2	0.65



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